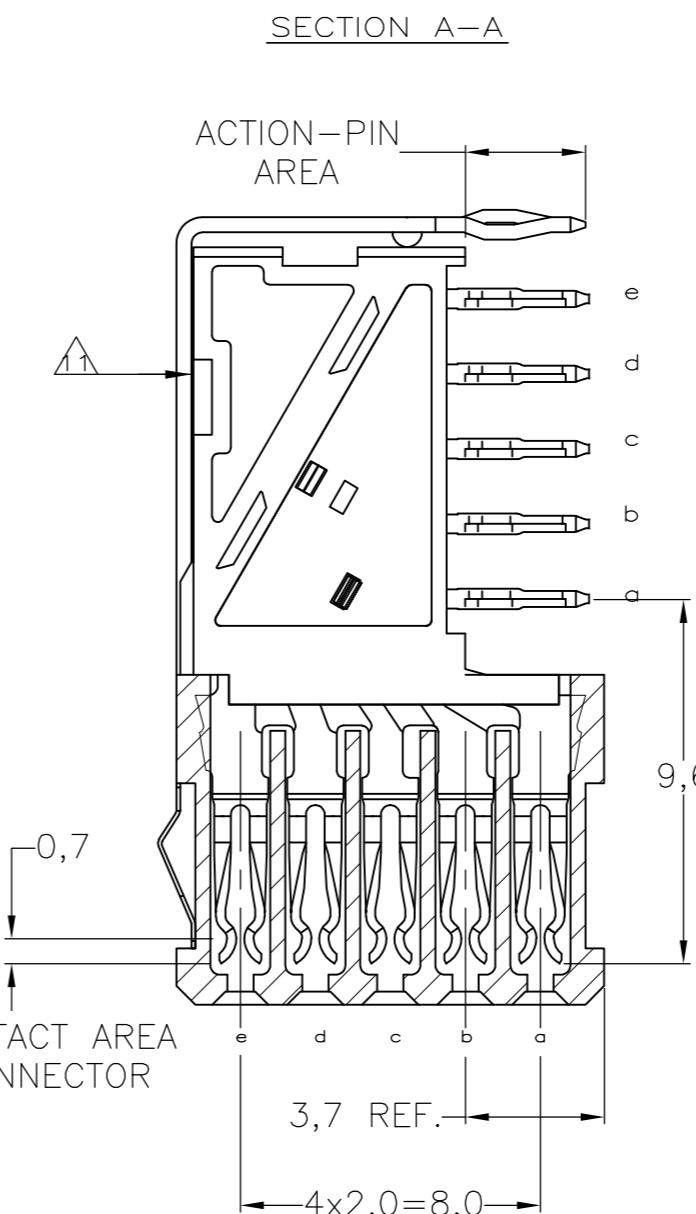
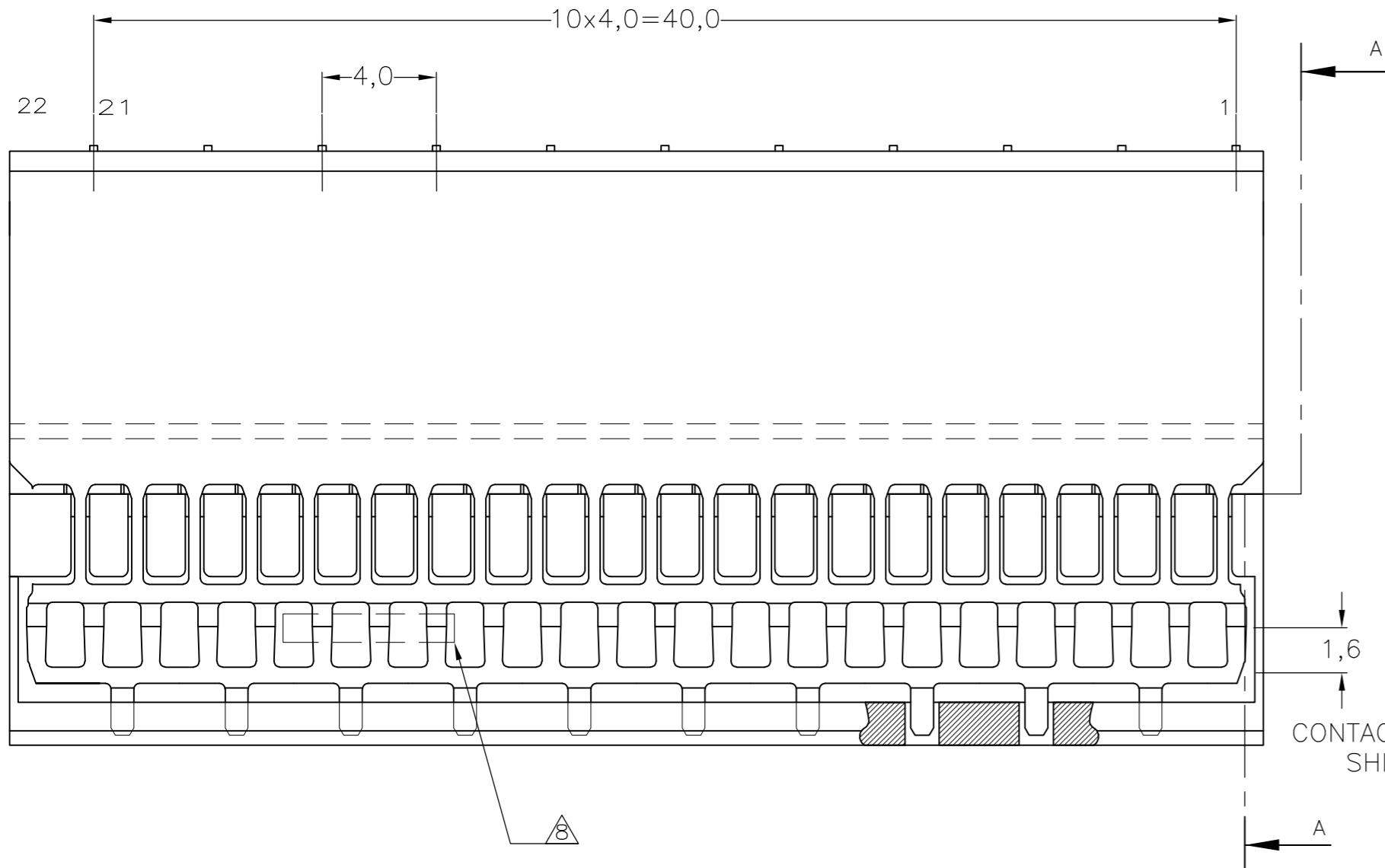


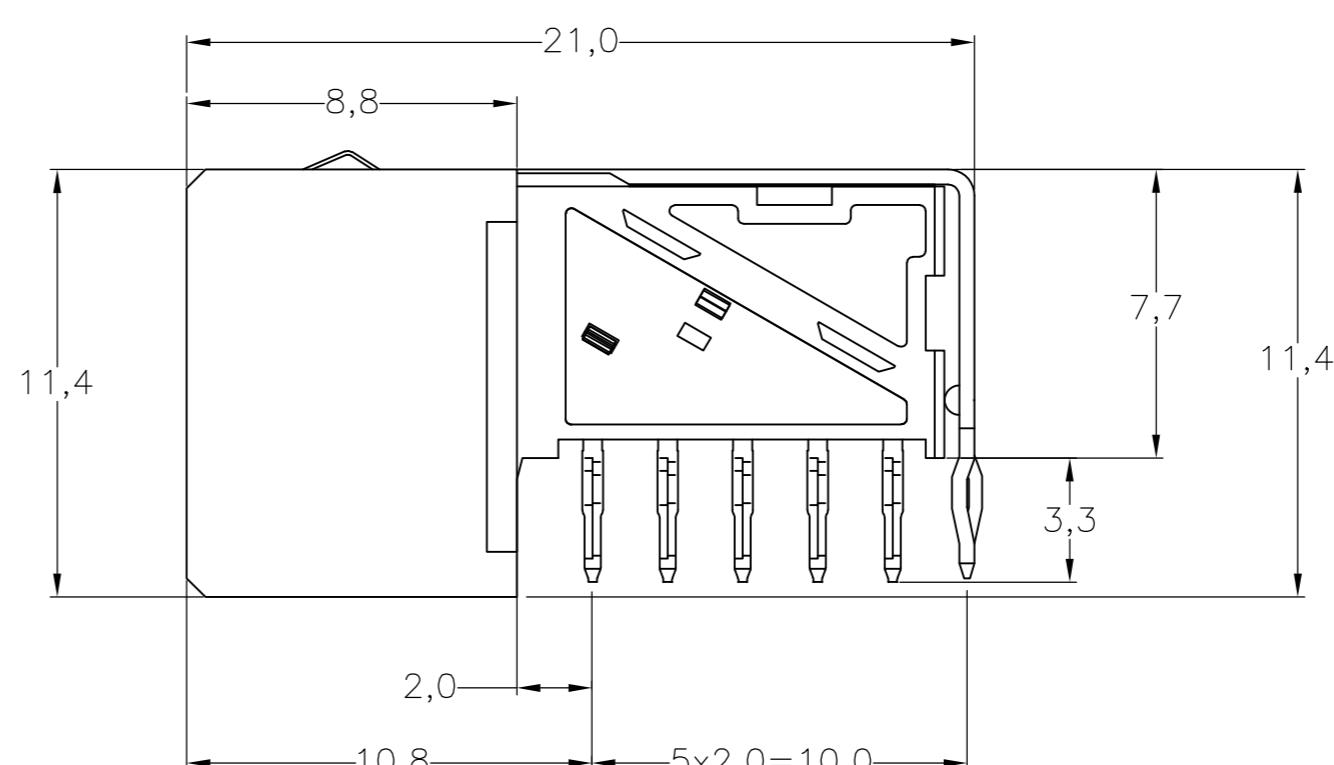
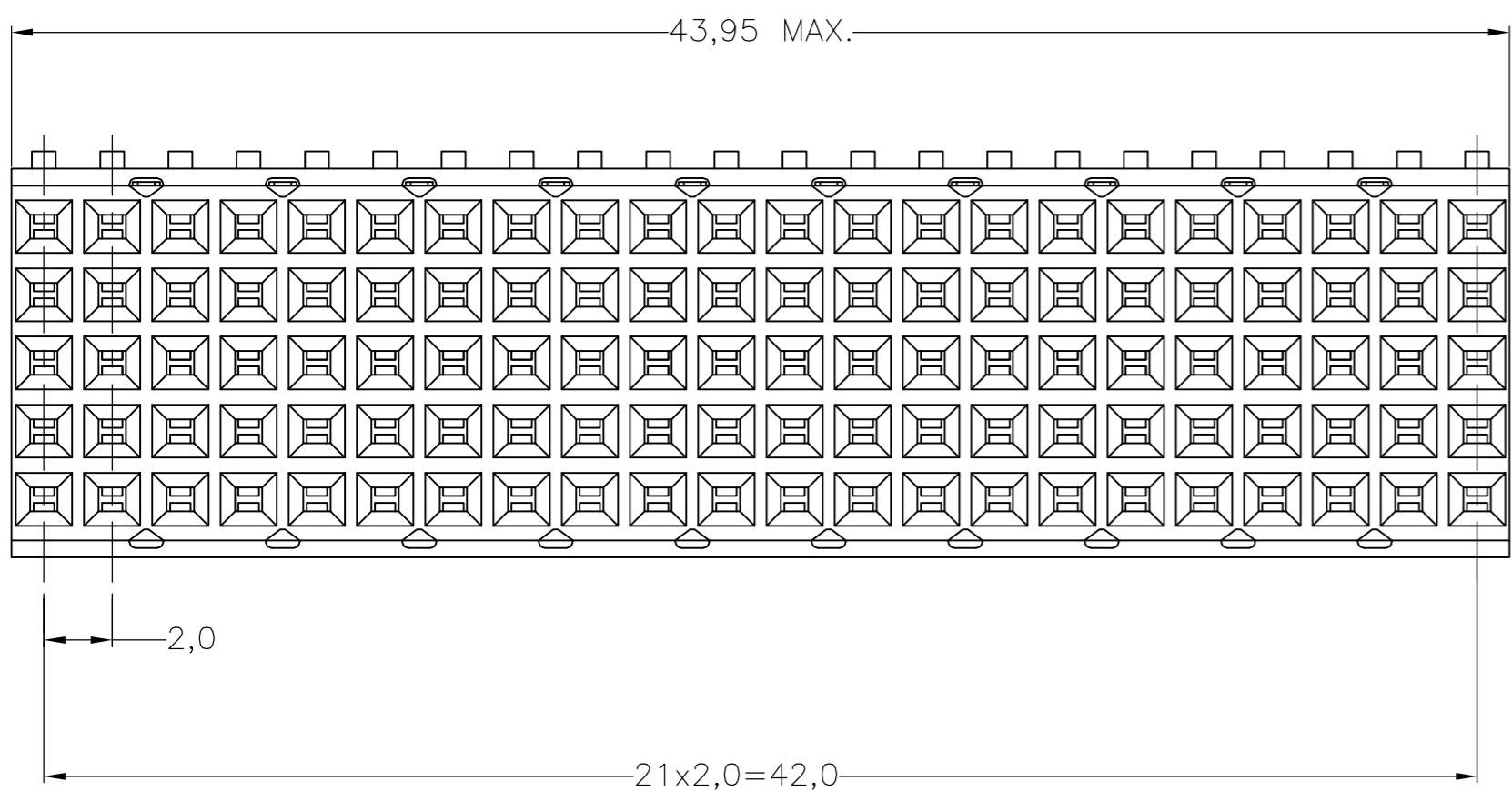
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LOC	DIST	REVISIONS				
		P	LTR	DESCRIPTION	DATE	
H	L	REVISED PER ECO-13-014710		07NOV2013	SY	FY



NOTES:

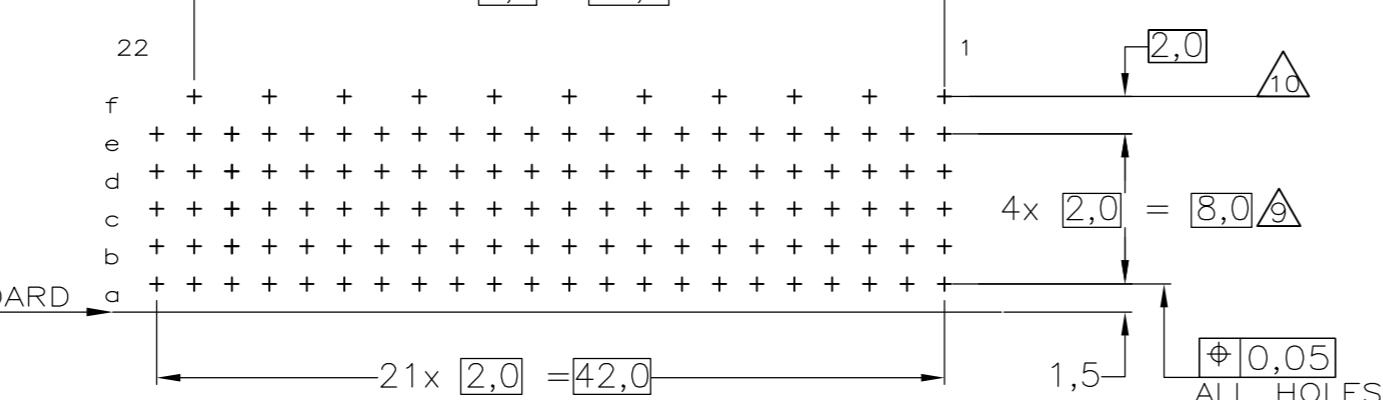
- 1 MATERIAL CONTACTS; PHOSPHORBRONZE
MATERIAL HOUSING; GLASSFILLED POLYESTER (GRAY)
- 2 GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT):
1,27µm NICKEL MIN. AND ACTION PIN: 0,5µm TIN-LEAD MIN.
FOR PLATING OF MATING SURFACES SEE APPLICABLE SPECIFICATION
REFERENCE FOR EACH DASH NUMBER.
- 3 CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101
PERFORMANCE LEVEL 2.
- 4 CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101
PERFORMANCE LEVEL 1.
- 5 CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA
GR-1217-CORE QUALITY LEVEL III, CENTRAL OFFICE APPLICATIONS.
- 6 CONNECTOR LUBRICATED WITH TELCORDIA APPROVED LUBRICANT.
- 8 ASSEMBLY PRINTED WITH P/N AND DATECODE
THE MARKING CAN APPEAR ON THE FRONT SIDE OR BACK SIDE.
- 9 HOLE PATTERN FOR FEMALE CONNECTOR TYPE B-22 COLUMNS
110 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID
- 10 ROW "f" 11 PLATED THROUGH HOLES FOR UPPERSHIELD
- 11 SHIELD MOUNTED ON CONNECTOR WITH DOUBLE SIDED
ADHESIVE TAPE OR ADHESIVE
- 12 BASIC P.N. LOWERSHIELD: 352468
- 13 OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI
- 14 0.76µm MIN GOLD PLATING ON MATING SURFACES



SCALE 2,5:1
COMPONENT SIDE AS SHOWN
RECOMMENDED PCB-HOLE LAY-OUT

P.C.B. HOLE DIM. ACTION PIN
FOR DETAILS SEE
APPLICATION SPECIFICATION

EDGE OF P.C.BOARD



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DRAWN BY	23SEP96	TE Connectivity
CHK	-	
APVD	-	
PRODUCT SPEC	-	
Z-PACK 2MM HM		
TYPE B - 22 COLUMNS		
PRE-SHIELDED RECEPTACLE		
SIZE	CAGE CODE	DRAWING NO
A2	00779	C-352152
RESTRICTED CUSTOMER		
SCALE	NTS	1 OF 1
REV	L	

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